PRELIMINARY SPEC

2.5X2.0mm SURFACE MOUNT LED LAMP

White

Part Number: AT2520QW10ZS

ATTENTION



OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- Dimension: 2.5mmx 2.0mm x 0.8mm.
- Low thermal resistance.
- Ceramic package with silicone resin.
- Higher brightness LED flash.
- Small package with high efficiency.
- Surface mount technology.
- ESD protection.
- Radiation patterns optimal for camera flash.
- Enables higher resolution pictures in darken environments.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 2a.
- Soldering methods: IR reflow soldering.
- RoHS compliant.

Application Note

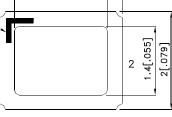
Static electricity and surge damage the LEDS. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. All devices, equipment and machinery must be electrically

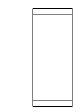
Typical Applications

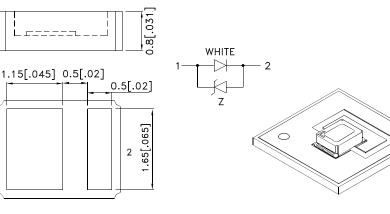
Digital still cameras Camera-phones PDAs Room lighting Architectural lighting Decorative/pathway lighting Front panel backlight Exterior automotive lighting: (brake lights, turn lights, backlighting)

2.5[.098] 1.9[.075] POLARITY MARK

1







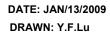
Notes:

1. All dimensions are in millimeters (inches).

- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Specifications are subject to change without notice.

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4. The device has a single mounting surface. The device must be mounted according to the specifications.



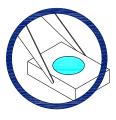
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Package Dimensions

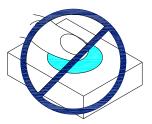
Handling Precautions

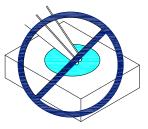
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

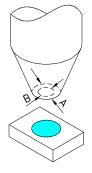




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



Selection Guide

Part No.	Dice	luminous Intensity [2] Φν (Im) [2] Iv(mcd)@ 250mA @ 250mA		Viewing Angle [1]		
		Min.	Тур.	Min.	Тур.	2 0 1/2
AT2520QW10ZS	WHITE (InGaAIN)	8000	12000	30	38	120 °

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity / luminous flux: +/-15%.

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit
Power dissipation	Pt	1.00	W
Junction temperature[1]	TJ	110	°C
Operating Temperature	Тор	-40 To +100	°C
Storage Temperature	Tstg	-40 To +120	°C
DC Forward Current [1]	lF	250	mA
Peak Forward Current [2]	Іғм	400	mA
Thermal resistance [1]	Rth j-a	110	°C/W
Electrostatic Discharge Threshold (HBM)		8000	V

Notes:

1. Results from mounting on PC board FR4, mounted on pc board-metal core PCB is recommend.

for lowest thermal resistance.

2. 1/10 Duty Cycle, 0.1ms Pulse Width.

Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Value	Unit
Chromaticity coordinate x acc.to CIE1931 IF=250mA [Typ.]	X [1]	0.31	-
Chromaticity coordinate y acc.to CIE1931 IF=250mA [Typ.]	Y [1]	0.31	-
Forward Voltage IF=250mA [Min.]		3.0	
Forward Voltage IF=250mA [Typ.]	VF [2]	3.5	V
Forward Voltage IF=250mA [Max.]		4.0	
Temperature coefficient of x IF=250mA, -10 $^\circ$ C ≤ T≤100 $^\circ$ C [Typ.]	TC x	0.15	10 ⁻³ /° C
Temperature coefficient of y IF=250mA, -10 $^\circ$ C ≤ T≤100 $^\circ$ C [Typ.]	ТСу	0.13	10 ⁻³ /° C
Temperature coefficient of VF IF=250mA, -10 $^\circ$ C \leq T \leq 100 $^\circ$ C $\ [Typ.]$	TCv	-3.2	mV/° C

Notes:

1.Measurement tolerance of the chromaticity coordinates is ± 0.01 . 2.Forward Voltage: $\pm -0.1V$.

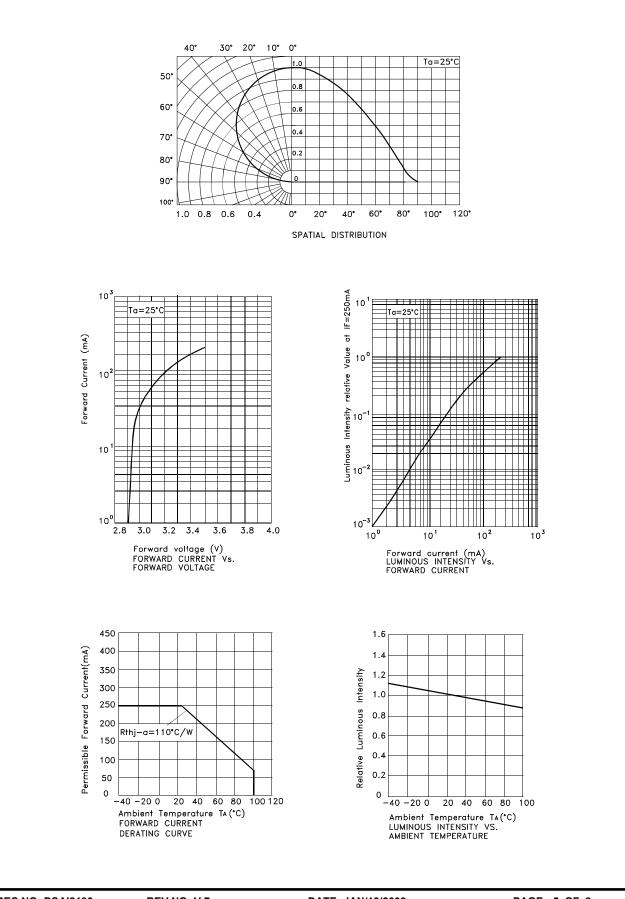
Summary of Practical Pulsing Configurations with Typical Thermal Management.

	Flash Pulse Current					
Flash Pulse Duration	0.35A	0.6A	1A	2A		
50 ms	ОК	ОК	OK	ОК		
100 ms	ОК	ОК	ОК	-		
200 ms	ОК	OK	-	-		
300 ms	ОК	-	-	-		

OK Signifies a transient temperature change of less than 40°C.

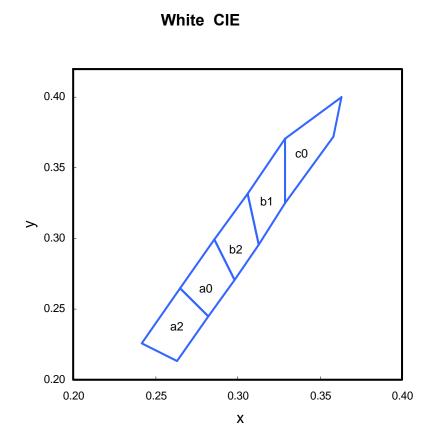
- Temperature change > 40°C, may require additional thermal management.

AT2520QW10ZS



SPEC NO: DSAI2180 APPROVED: WYNEC DATE: JAN/13/2009 DRAWN: Y.F.Lu

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Rank a2				
х	0.263	0.282	0.265	0.242
у	0.213	0.245	0.265	0.226

Rank b2						
х	0.298	0.313	0.306	0.286		
y 0.271 0.296 0.332 0.299						

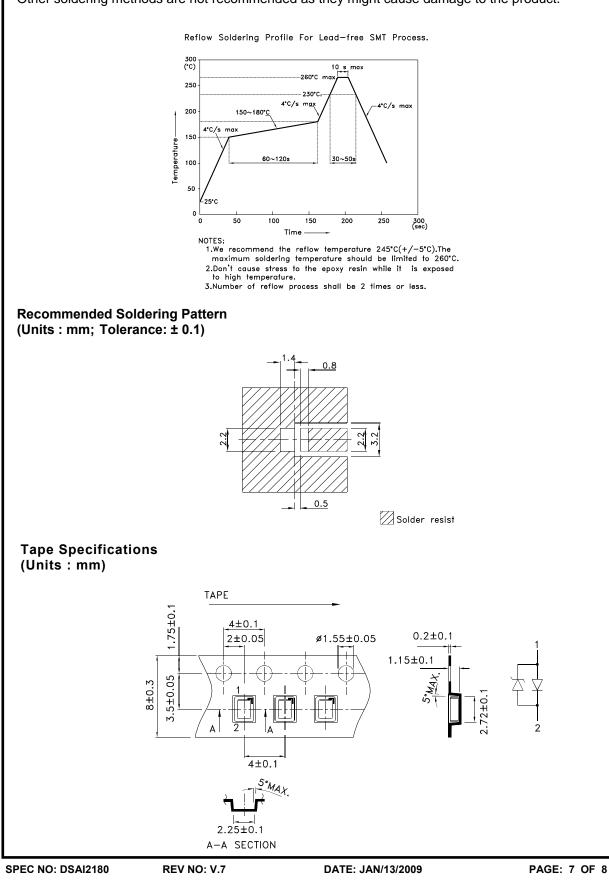
Rank c0				
х	0.329	0.358	0.363	0.329
у	0.325	0.372	0.400	0.371

Rank a0						
х	0.282	0.298	0.286	0.265		
y 0.245 0.271 0.299 0.265						

Rank b1				
x	0.313	0.329	0.329	0.306
у	0.296	0.325	0.371	0.332

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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.



CHECKED: Allen Liu

DRAWN: Y.F.Lu

ERP: 1212000119

